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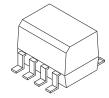




MOC215-M MOC216-M MOC217-M

DESCRIPTION

These devices consist of a gallium arsenide infrared emitting diode optically coupled to a monolithic silicon phototransistor detector, in a surface mountable, small outline, plastic package. They are ideally suited for high density applications, and eliminate the need for through—the—board mounting.



FEATURES

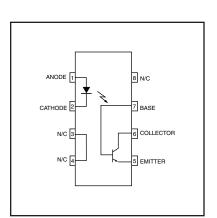
- UL Recognized (File #E90700, Volume 2)
- VDE Recognized (File #13616) (add option "V" for VDE approval, i.e., MOC215V-M)
- · Convenient Plastic SOIC-8 Surface Mountable Package Style
- Low LED Input Current Required, for Easier Logic Interfacing
- Standard SOIC–8 Footprint, with 0.050" Lead Spacing
- · Compatible with Dual Wave, Vapor Phase and IR Reflow Soldering
- High Input-Output Isolation of 2500 Vac (rms) Guaranteed

APPLICATIONS

- · Low power Logic Circuits
- Interfacing and coupling systems of different potentials and impedances
- · Telecommunications equipment
- Portable electronics

Marking Information:

- MOC215-M = 215
- MOC216-M = 216
- MOC217-M = 217





Rating	Symbol	Value	Unit
EMITTER			
Forward Current - Continuous	I _F	60	mA
Forward Current - Peak (PW = 100 µs, 120 pps)	I _F (pk)	1.0	А
Reverse Voltage	V _R	6.0	V
LED Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	90 0.8	mW mW/°C
DETECTOR			
Collector-Emitter Voltage	V _{CEO}	30	V
Collector-Base Voltage	V _{CBO}	70	V
Emitter-Collector Voltage	V _{ECO}	7.0	V
Collector Current-Continuous	I _C	150	mA
Detector Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	150 1.76	mW mW/°C
TOTAL DEVICE			
Input-Output Isolation Voltage ^(1,2) (60 Hz, 1 minute duration)	V _{ISO}	2500	Vac(rms)
Total Device Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	250 2.94	mW mW/°C
Ambient Operating Temperature Range	T _A	-40 to +100	°C
Storage Temperature Range	T _{stg}	-40 to +125	°C



Characteristic			Symbol	Min	Тур**	Max	Unit
EMITTER							
Forward Voltage		$(I_F = 1.0 \text{ mA})$	V _F	_	1.07	1.3	V
Reverse Leakage Current		$(V_{R} = 6.0 \text{ V})$	I _R	_	0.001	100	μΑ
Capacitance			С	_	18	_	pF
DETECTOR							
Collector-Emitter Dark Current —		$(V_{CE} = 5.0 \text{ V}, T_A = 25^{\circ}\text{C})$	I _{CEO}	_	1.0	50	nA
		$(V_{CE} = 5.0 \text{ V}, T_{A} = 100^{\circ}\text{C})$		_	1.0	_	μΑ
Collector-Emitter Breakdown Voltage		$(I_C = 100 \mu A)$	BV _{CEO}	30	100		V
Emitter-Collector Breakdown Voltage		$(I_E = 100 \mu A)$	BV _{ECO}	7.0	10	_	V
Collector-Emitter Capacitance		$(f = 1.0 \text{ MHz}, V_{CE} = 0)$	C _{CE}	_	7.0	_	pF
COUPLED Output Collector Current ⁽⁴⁾	MOC215-M MOC216-M MOC217-M	$(I_F = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V})$	CTR	20 50 100	_ _ _	_ _ _	%
Collector-Emitter Saturation	Voltage	$(I_C = 100\mu A, I_F = 1.0mA)$	V _{CE(sat)}	_	_	0.4	V
Turn-On Time		$(I_C = 2.0 \text{ mA}, V_{CC} = 10 \text{ V},$ $R_L = 100 \Omega$, fig. 10)	t _{on}	_	4.0	_	μs
Turn-Off Time		$(I_C = 2.0 \text{ mA}, V_{CC} = 10 \text{ V},$ $R_L = 100 \Omega$, fig. 10)	t _{off}	_	4.0	_	μs
Rise Time		$(I_C = 2.0 \text{ mA}, V_{CC} = 10 \text{ V},$ $R_L = 100 \Omega$, fig. 10)	t _r	_	3.0	_	μs
Fall Time		$(I_C = 2.0 \text{ mA}, V_{CC} = 10 \text{ V},$ $R_L = 100 \Omega$, fig. 10)	t _f	_	3.0	_	μs
Input-Output Isolation Voltag	je ^(1,2,3)	(f = 60 Hz, t = 1.0 min.)	V _{ISO}	2500	_	_	Vac(rms
Isolation Resistance ⁽²⁾		$(V_{I-O} = 500 \text{ V})$	R _{ISO}	10 ¹¹	_	_	Ω
Isolation Capacitance ⁽²⁾		$(V_{I-O} = 0, f = 1.0 \text{ MHz})$	C _{ISO}	_	0.2	_	pF

^{**} Typical values at T_A = 25°C unless otherwise noted.

^{1.} Input-Output Isolation Surge Voltage, V_{ISO} , is an internal device dielectric breakdown rating.

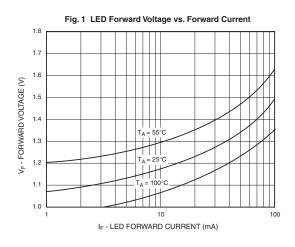
^{2.} For this test, Pins 1 and 2 are common and Pins 5, 6 and 7 are common.

^{3.} V_{ISO} rating of 2,500 $V_{AC(RMS)}$ for t = 1 minute is equivalent to a rating of 3,000 $V_{AC(RMS)}$ for t = 1 second.

^{4.} Current Transfer Ratio (CTR) = $I_C/I_F x$ 100%.

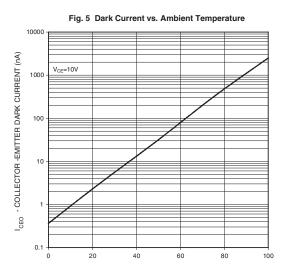


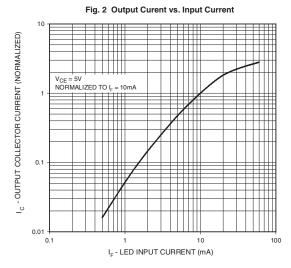
MOC215-M MOC216-M MOC217-M

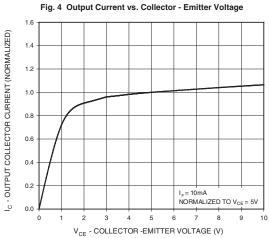


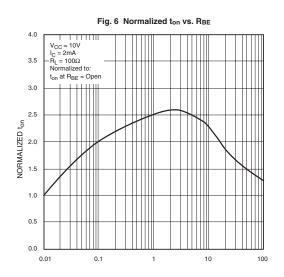
 T_A - AMBIENT TEMPERATURE (°C)

Fig. 3 Output Current vs. Ambient Temperature







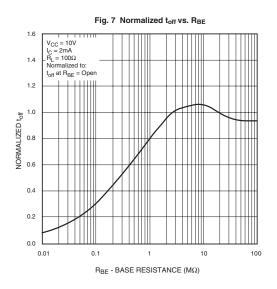


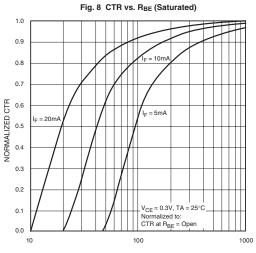
0.1

-80

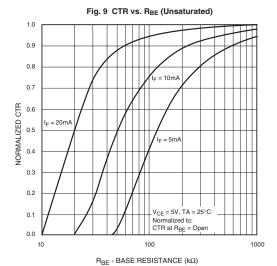


MOC215-M MOC216-M MOC217-M





 R_{BE} - BASE RESISTANCE (k Ω)





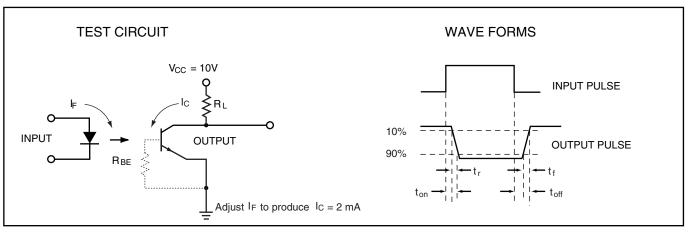
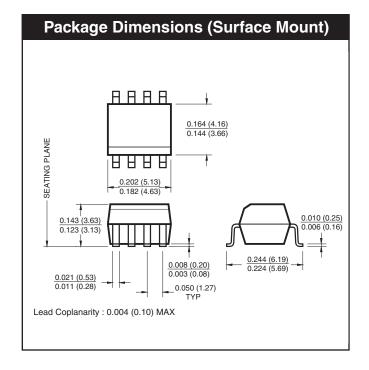
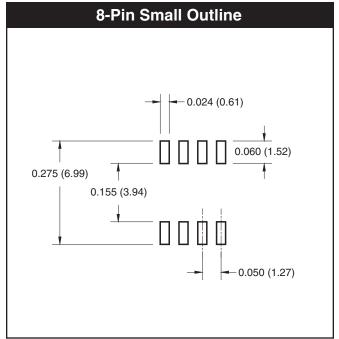


Figure 10. Switching Time Test Circuit and Waveforms





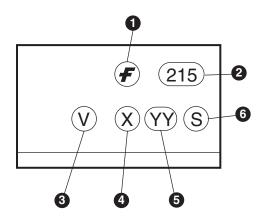


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ORDERING INFORMATION

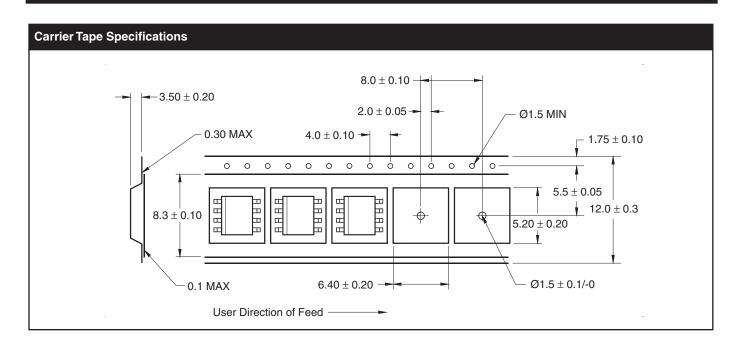
Option	Order Entry Identifier	Description
V	V	VDE 0084
R1	R1	Tape and reel (500 units per reel)
R1V	R1V	VDE 0884, Tape and reel (500 units per reel)
R2	R2	Tape and reel (2500 units per reel)
R2V	R2V	VDE 0884, Tape and reel (2500 units per reel)

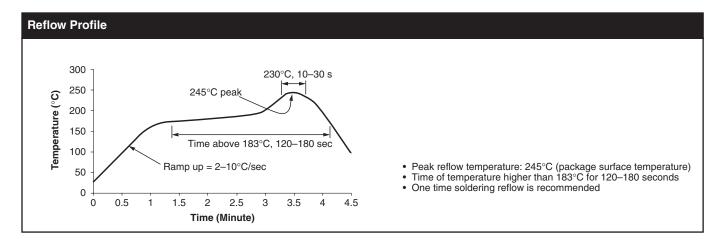
MARKING INFORMATION



Definitions				
1	Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	One digit year code, e.g., '3'			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			









MOC215-M MOC216-M MOC217-M

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